Special Issue

Revolutionizing Manufacturing: Advances in Additive Manufacturing Technologies

Message from the Guest Editors

Dear colleagues, We are thrilled to introduce our Special Issue, entitled "Revolutionizing Manufacturing: Advances in Additive Manufacturing Technologies." This exceptional edition delves into the captivating realm of Additive Manufacturing, more commonly known as 3D printing, and its profound impact on the landscape of modern industry. Additive Manufacturing has emerged as a catalyst for innovation by reshaping traditional design and manufacturing processes, and enabling the creation of intricate, customized, and sustainable products. Key themes include advancements in materials, novel 3D printing techniques, improvements in post-processing methods, and the integration of Additive Manufacturing into various industries, from aerospace and healthcare to automotive and consumer goods. We invite you and your peers to bring forward your insights, and expertise. Contributions that highlight inventive solutions, disruptive technologies, and realworld applications that are pushing the boundaries of what is today possible within Additive Manufacturing are all welcome.

Guest Editors

Prof. Dr. Ismail Fidan

Dr. Evren Yasa

Dr. Vladimir Popov

Deadline for manuscript submissions

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Editors-in-Chief

Prof. Dr. Chien-Hung Liu Department of Mechanical Engineering, National Chung Hsing University, 250 Kuo Kuang Rd., Taichung 402, Taiwan

Prof. Dr. Shoou-Jinn Chang Department of Electrical Engineering, National Cheng Kung University, Tainan 701, Taiwan

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